

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/648,942
Applicant(s) : Wong *et al.*
Filed : August 27, 2003
Title : Low Density High Loft Nonwoven Substrates
TC/A.U. : 1771
Examiner : N. L. TORRES VELAZQUEZ
Conf. No. : 5927
Docket No. : CM2656M

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RESPONSE TO NOTICE OF NON-COMPLIANCE DATED AUGUST 3, 2005**RESPONSE TO OFFICE ACTION MAILED 6/01/2005
(RESUBMITTED)**

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY REMARKS

In response to the Office Action dated June 1, 2005, Applicants hereby submit this response including the following amendments and remarks.

This Response is filed within three (3) months of the mailing date of the above-referenced Office Action and therefore is timely filed in accordance with 37 CFR § 1.8.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 7 of this paper.